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(12) **United States Design Patent**
Shibukawa

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(54) **HEADPHONE**

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(52) **U.S. Cl.**
USPC **D14/205**

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2/209; 381/380, 381, 383, 370;
455/90.3, 575.1, 569.1
CPC H04R 25/00; H04R 1/1016; H04R 1/1066;
H04R 5/033; H04R 5/0335; H04R 1/105;
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1/1091; H04R 1/1058

See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a headphone, as shown.

DESCRIPTION

FIG. 1 is a perspective view of a first embodiment of a headphone showing my new design; FIG. 2 is a front elevational view thereof; FIG. 3 is a rear elevational view thereof; FIG. 4 is a left side elevational view thereof; FIG. 5 is a right side elevational view thereof; FIG. 6 is a top plan view thereof; and, FIG. 7 is a bottom plan view thereof.

1 Claim, 7 Drawing Sheets



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FIG. 1



FIG. 2



FIG. 3



FIG. 4



FIG. 5

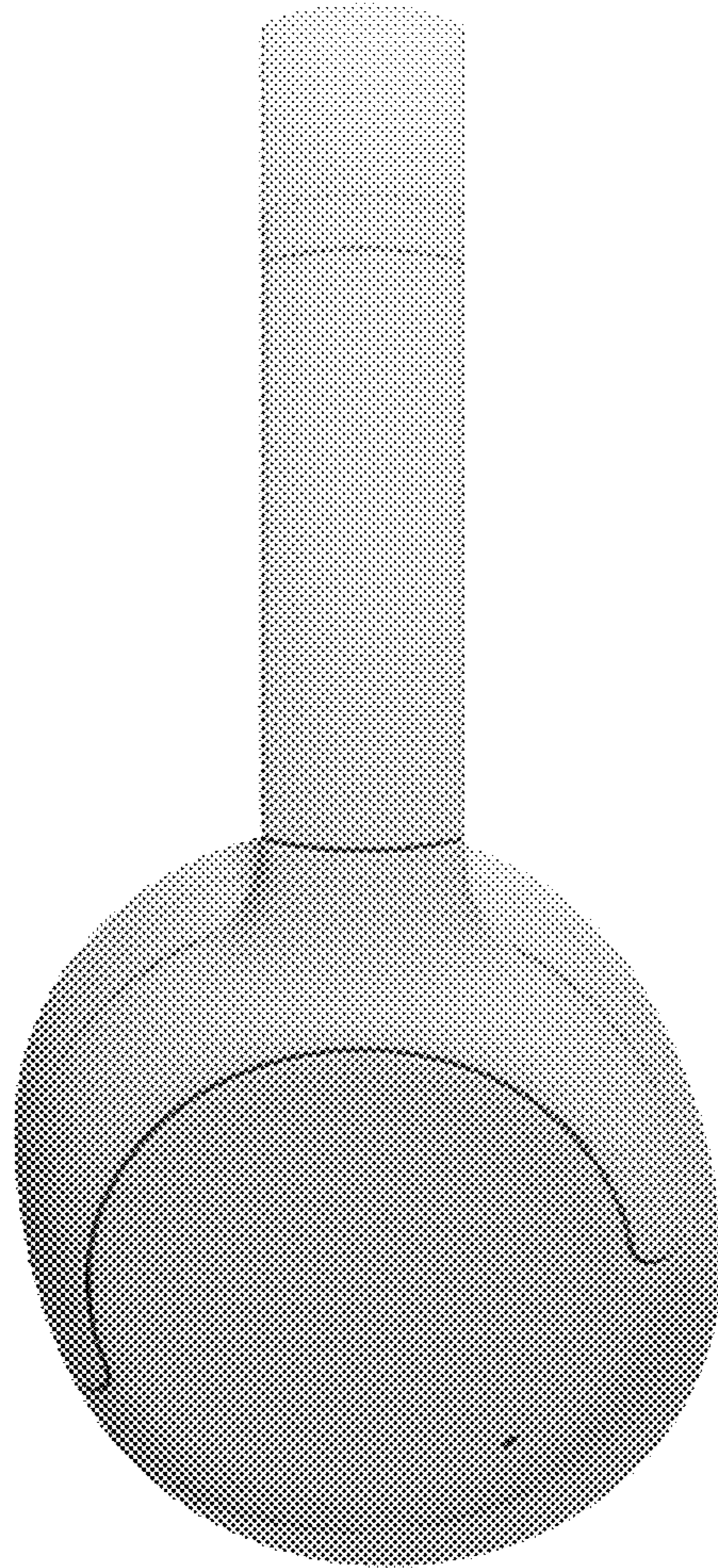


FIG. 6

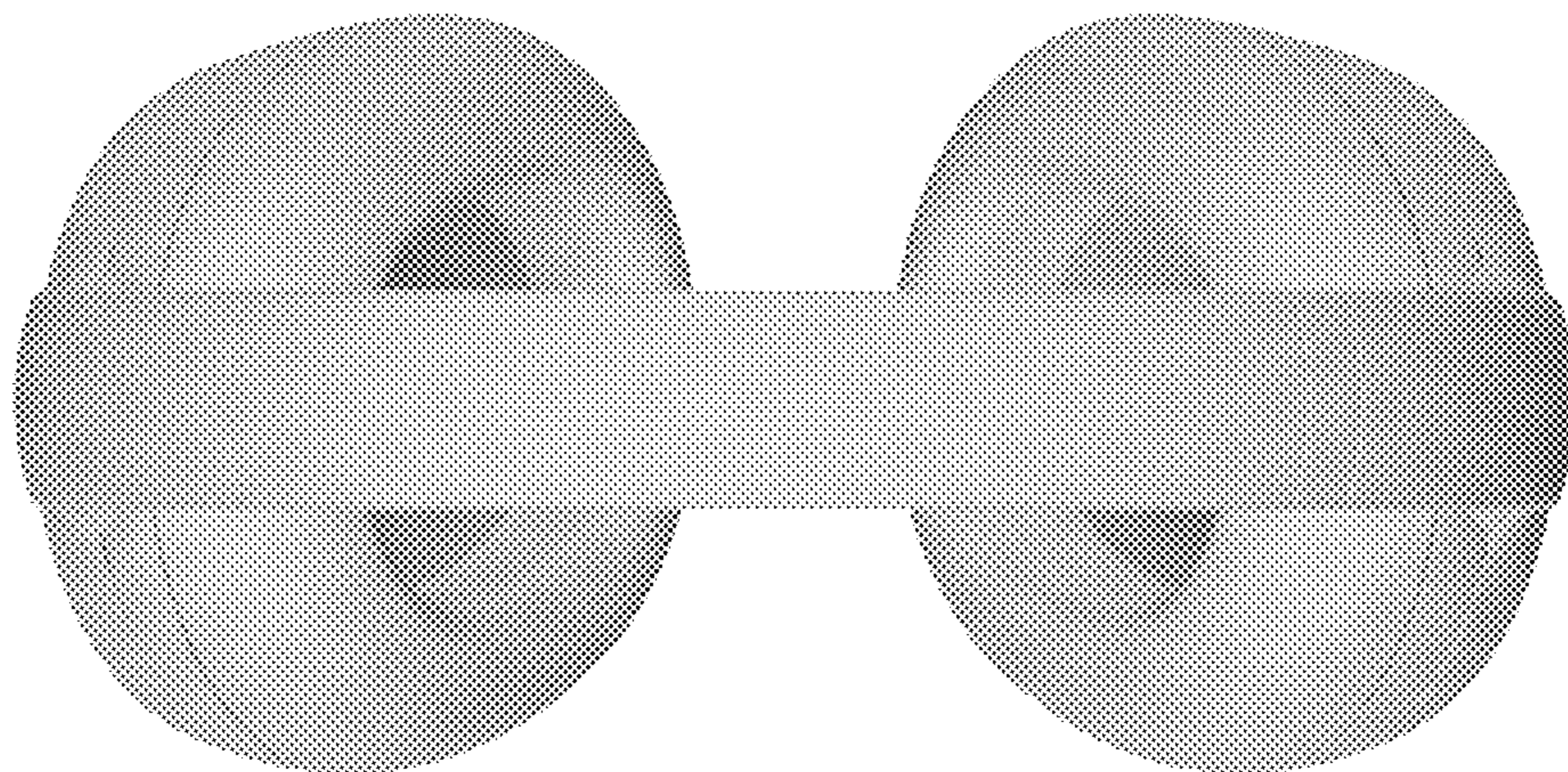


FIG. 7

